

# Surface Mount Fast Recovery Rectifiers

### **FEATURES:**

- · For surface mounted applications
- · Low profile package
- Glass Passivated Chip Junction
- · Easy to pick and place
- Lead free in comply with EU RoHS 2011/65/EU directives

## **Circuit Diagram & Pin Configuration:**





#### Marking

Type number	Marking code
RS1AF	RS1A
RS1BF	RS1B
RS1DF	RS1D
RS1GF	RS1G
RS1JF	RS1J
RS1KF	RS1K
RS1MF	RS1M

#### **Absolute Maximum Ratings and Characteristics**

Ratings at 25 °C ambient temperature unless otherwise specified. Single phase, half wave, 60 Hz, resistive or inductive load. For capacitive load, derate current by 20%.

Parameter	Symbols	RS1AF	RS1BF	RS1DF	RS1GF	RS1JF	RS1KF	RS1MF	Units
Maximum Repetitive Peak Reverse Voltage	$V_{RRM}$	50	100	200	400	600	800	1000	V
Maximum RMS voltage	V <sub>RMS</sub>	35	70	140	280	420	560	700	V
Maximum DC Blocking Voltage	V <sub>DC</sub>	50	100	200	400	600	800	1000	V
Maximum Average Forward Rectified Current at T <sub>c</sub> = 125 °C	I <sub>F(AV)</sub>	1							А
Peak Forward Surge Current 8.3 ms Single Half Sine Wave Superimposed on Rated Load	I <sub>FSM</sub>	30							Α
Maximum Forward Voltage at 1 A	V <sub>F</sub>	1.3							٧
Maximum DC Reverse Current $T_a = 25 ^{\circ}\text{C}$ at Rated DC Blocking Voltage $T_a = 125 ^{\circ}\text{C}$	I <sub>R</sub>	5 50							μA
Typical Junction Capacitance at V <sub>R</sub> =4V, f=1MHz	C <sub>j</sub>	15						pF	
Maximum Reverse Recovery Time (1)	t <sub>rr</sub>	150 250 500				00	ns		
Typical Thermal Resistance (2)	$R_{ heta_{JA}}$ $R_{ heta_{JL}}$	80 30							°C/W
Operating and Storage Temperature Range	$T_{j},T_{stg}$	-55 ~ +150							°C

<sup>( 1 )</sup> Measured with  $I_{\scriptscriptstyle F}$  = 0.5 A,  $I_{\scriptscriptstyle R}$  = 1 A,  $I_{\scriptscriptstyle rr}$  = 0.25 A.

<sup>(</sup> 2 ) P.C.B. mounted with 2.0" X 2.0" (5 X 5 cm) copper pad areas.



Fig.1 Forward Current Derating Curve

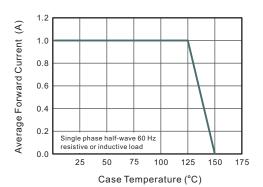


Fig.2 Typical Reverse Characteristics

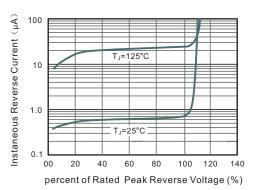


Fig.3 Typical Instaneous Forward Characteristics

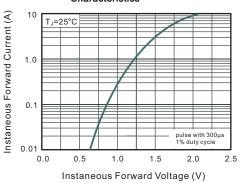


Fig.4 Typical Junction Capacitance

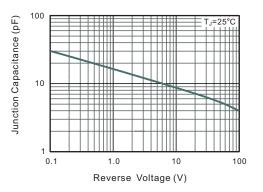
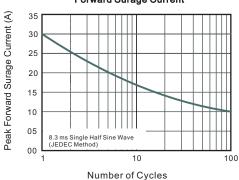


Fig.5 Maximum Non-Repetitive Peak Forward Surage Current

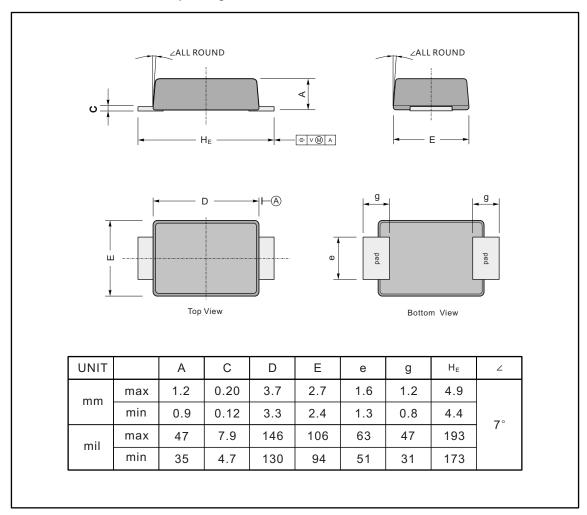




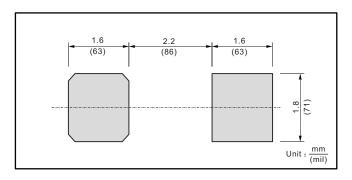
#### PACKAGE OUTLINE

### Plastic surface mounted package; 2 leads

#### **SMAF**



### The recommended mounting pad size





### **NOTICE**

The information presented in this document is for reference only. Tinysemi reserves the right to make changes without notice for the specification of the products displayed herein.

The product listed herein is designed to be used with ordinary electronic equipment or devices, and not designed to be used with equipment or devices which require high level of reliability and the malfunction of with would directly endanger human life (such as medical instruments, transportation equipment, aerospace machinery, nuclear-reactor controllers, fuel controllers and other safety devices), Tinysemi elec Co., Ltd., or anyone on its behalf, assumes noresponsibility or liability for any damagers resulting from such improper use of sale.

This publication supersedes & replaces all information reviously supplied. For additional information, please visit our website http://www.tinysemi.com , or consult your nearest Tinysemi's sales office for further assistance.